SURFACE MOUNT

Bias Tee

JEBT-4R2G+

50Ω Wideband 10 to 4200 MHz

FEATURES

- Wideband, 10 to 4200 MHz
- Low Insertion Loss, 0.6 dB Typ.
- Good Isolation, 40 dB Typ.



Generic photo used for illustration purposes only

CASE STYLE: BL301

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Biasing Amplifiers, Laser Diodes, Active Antenna
- DC Return
- DC Blocking
- Satellite Communication

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		10		4200	MHz
Insertion Loss[1]	10-1000		0.15	0.6	dB
	1000-2100		0.6	1.2	
	2100-4200		0.6	1.6	
Isolation[1] (RF Port to DC Port) (RF & DC Port to DC Port)	10-1000	20	32		dB
	1000-2100	20	40		
	2100-4200	20	40		

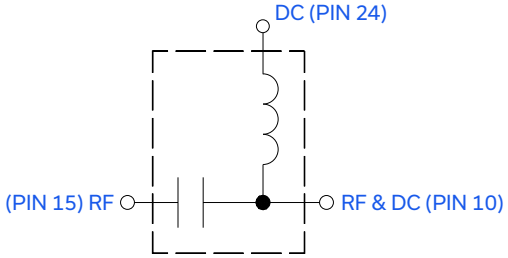
1. Insertion Loss and Isolation are guaranteed up to +20 dBm - RF power and 200 mA DC current.

ABSOLUTE MAXIMUM RATINGS

Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	+30 dBm max.
Voltage at DC Port	+25 V max.
Input Current	500 mA
DC Resistance from DC to RF & DC Port	4.5Ω typ.

Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



REV. E
ECO-027902
JEBT-4R2G+
MCL NY
251208

SURFACE MOUNT

Bias Tee

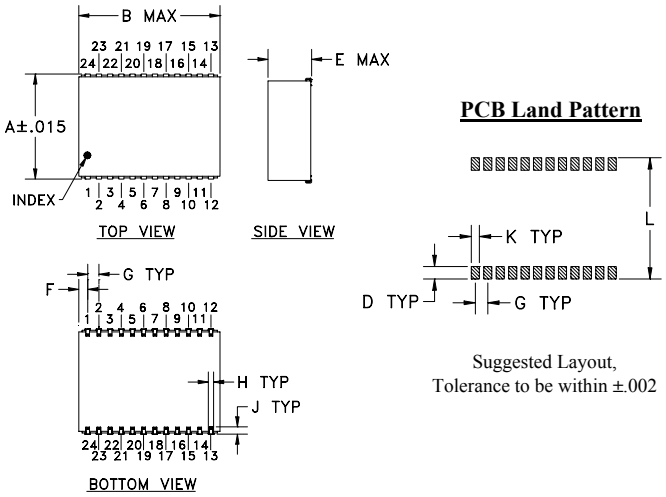
JEBT-4R2G+

50Ω Wideband 10 to 4200 MHz

PIN CONNECTIONS

RF	15
RF & DC	10
DC	24
GROUND	All Other Pins

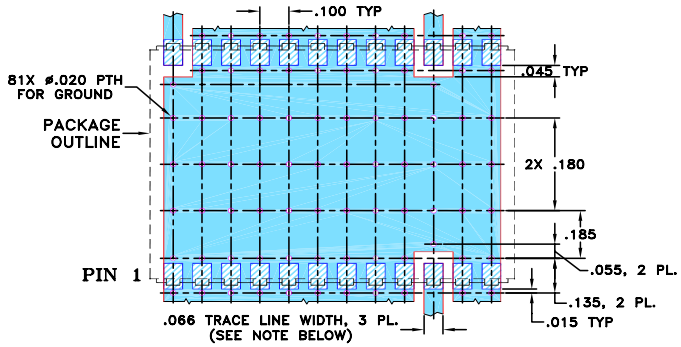
OUTLINE DRAWING



PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-JEBT-4R2G+

SUGGESTED PCB LAYOUT (PL-216)



NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F
.940	1.260	--	.100	.390	.080
23.88	32.00	--	2.54	9.91	2.03

G	H	J	K	L	wt
.100	.047	.065	.065	.970	grams
2.54	1.19	1.65	1.65	24.64	7.2

TAPE & REEL INFORMATION: F25

SURFACE MOUNT

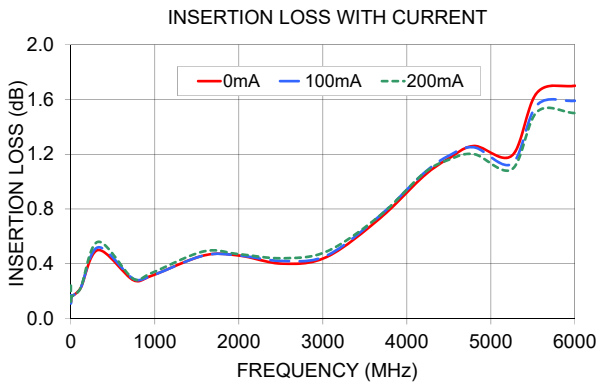
Bias Tee

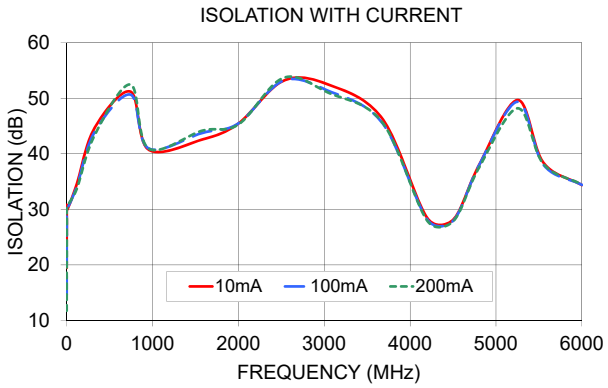
JEBT-4R2G+

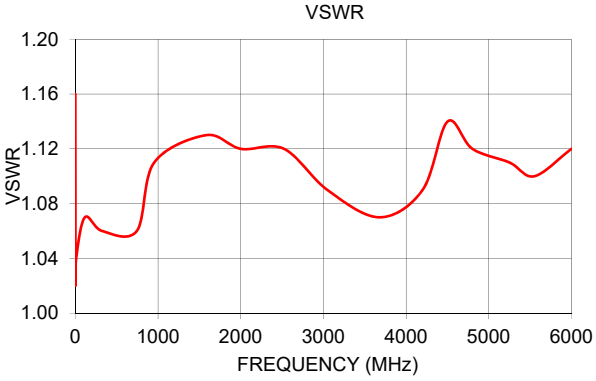
50Ω Wideband 10 to 4200 MHz

TYPICAL PERFORMANCE DATA

Freq. (MHz)	P_{IN} (dBm)	Insertion Loss (dB) With Current						Isolation (dB) (P_{IN} = -10 dBm) With Current						VSWR (:1)
		0 mA	20 mA	50 mA	100 mA	150 mA	200 mA	10 mA	20 mA	50 mA	100 mA	150 mA	200 mA	
0.10	19.80	0.17	0.17	0.16	0.17	0.20	0.24	19.46	19.04	17.83	14.58	12.66	11.75	1.16
0.27	19.80	0.13	0.13	0.13	0.14	0.14	0.15	25.86	25.53	24.52	21.43	19.31	18.16	1.07
0.53	19.80	0.12	0.12	0.12	0.11	0.11	0.11	29.17	28.98	28.36	26.18	24.40	23.37	1.04
1.06	19.80	0.13	0.13	0.12	0.11	0.12	0.12	30.81	30.74	30.56	29.62	28.62	27.92	1.02
10.00	18.50	0.16	0.17	0.17	0.16	0.16	0.16	30.06	30.07	30.07	30.20	30.38	30.56	1.04
114.75	19.50	0.22	0.25	0.24	0.22	0.22	0.22	34.45	34.49	34.27	33.99	33.83	33.59	1.07
324.25	19.70	0.50	0.55	0.53	0.52	0.53	0.56	44.65	44.61	44.25	43.90	43.91	43.34	1.06
743.25	18.70	0.28	0.31	0.30	0.29	0.29	0.29	51.19	50.50	50.16	50.65	51.69	52.47	1.06
952.75	18.20	0.31	0.33	0.33	0.31	0.32	0.33	40.75	40.80	40.97	40.97	40.93	40.95	1.11
1581.25	18.00	0.46	0.48	0.47	0.46	0.48	0.49	42.58	42.59	43.94	43.77	44.36	44.17	1.13
2000.25	17.10	0.46	0.48	0.47	0.46	0.46	0.47	45.46	45.57	45.73	45.48	46.14	45.28	1.12
2524.00	14.40	0.40	0.42	0.41	0.42	0.43	0.44	53.15	53.72	52.19	53.17	52.67	53.67	1.12
3047.75	14.20	0.45	0.48	0.47	0.46	0.46	0.49	52.46	52.25	51.55	51.33	51.46	50.99	1.09
3676.25	15.10	0.73	0.74	0.75	0.75	0.75	0.75	46.32	47.19	46.36	45.53	46.19	45.65	1.07
4200.00	17.90	1.04	1.07	1.07	1.06	1.05	1.06	28.42	28.36	28.24	28.14	28.01	27.92	1.09
4502.50	-0.60	1.17	1.19	1.18	1.19	1.17	1.16	28.15	28.10	28.05	27.96	27.84	27.87	1.14
4802.00	-0.70	1.26	1.26	1.27	1.25	1.22	1.20	37.95	38.01	38.19	37.93	37.58	37.51	1.12
5251.75	-1.10	1.19	1.17	1.16	1.13	1.11	1.09	49.68	51.04	49.12	49.37	49.13	48.19	1.11
5550.75	-2.00	1.65	1.63	1.60	1.56	1.54	1.51	38.44	38.56	38.36	38.07	37.85	38.19	1.10
6000.00	-2.40	1.70	1.71	1.65	1.59	1.54	1.50	34.37	34.36	34.23	34.40	34.49	34.48	1.12







NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Bias Tee , Surface Mount JEBT-4R2G+

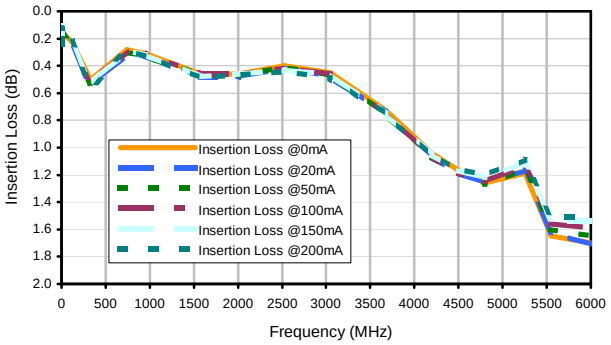
Typical Performance Data

FREQ. (MHz)	INSERTION LOSS with current (RF Port to RF&DC Port) (dB)						ISOLATION with current (RF Port to DC Port, RF&DC Port to DC Port) (dB)						VSWR (:1)
	0mA	20mA	50mA	100mA	150mA	200mA	10mA	20mA	50mA	100mA	150mA	200mA	
0.10	0.17	0.17	0.16	0.17	0.20	0.24	19.46	19.04	17.83	14.58	12.66	11.75	1.16
0.27	0.13	0.13	0.13	0.14	0.14	0.15	25.86	25.53	24.52	21.43	19.31	18.16	1.07
0.53	0.12	0.12	0.12	0.11	0.11	0.11	29.17	28.98	28.36	26.18	24.40	23.37	1.04
1.06	0.13	0.13	0.12	0.11	0.12	0.12	30.81	30.74	30.56	29.62	28.62	27.92	1.02
10.00	0.16	0.17	0.17	0.16	0.16	0.16	30.06	30.07	30.07	30.20	30.38	30.56	1.04
114.75	0.22	0.25	0.24	0.22	0.22	0.22	34.45	34.49	34.27	33.99	33.83	33.59	1.07
324.25	0.50	0.55	0.53	0.52	0.53	0.56	44.65	44.61	44.25	43.90	43.91	43.34	1.06
743.25	0.28	0.31	0.30	0.29	0.29	0.29	51.19	50.50	50.16	50.65	51.69	52.47	1.06
952.75	0.31	0.33	0.33	0.31	0.32	0.33	40.75	40.80	40.97	40.97	40.93	40.95	1.11
1581.25	0.46	0.48	0.47	0.46	0.48	0.49	42.58	42.59	43.94	43.77	44.36	44.17	1.13
2000.25	0.46	0.48	0.47	0.46	0.46	0.47	45.46	45.57	45.73	45.48	46.14	45.28	1.12
2524.00	0.40	0.42	0.41	0.42	0.43	0.44	53.15	53.72	52.19	53.17	52.67	53.67	1.12
3047.75	0.45	0.48	0.47	0.46	0.46	0.49	52.46	52.25	51.55	51.33	51.46	50.99	1.09
3676.25	0.73	0.74	0.75	0.75	0.75	0.75	46.32	47.19	46.36	45.53	46.19	45.65	1.07
4200.00	1.04	1.07	1.07	1.06	1.05	1.06	28.42	28.36	28.24	28.14	28.01	27.92	1.09
4502.50	1.17	1.19	1.18	1.19	1.17	1.16	28.15	28.10	28.05	27.96	27.84	27.87	1.14
4802.00	1.26	1.26	1.27	1.25	1.22	1.20	37.95	38.01	38.19	37.93	37.58	37.51	1.12
5251.75	1.19	1.17	1.16	1.13	1.11	1.09	49.68	51.04	49.12	49.37	49.13	48.19	1.11
5550.75	1.65	1.63	1.60	1.56	1.54	1.51	38.44	38.56	38.36	38.07	37.85	38.19	1.10
6000.00	1.70	1.71	1.65	1.59	1.54	1.50	34.37	34.36	34.23	34.40	34.49	34.48	1.12

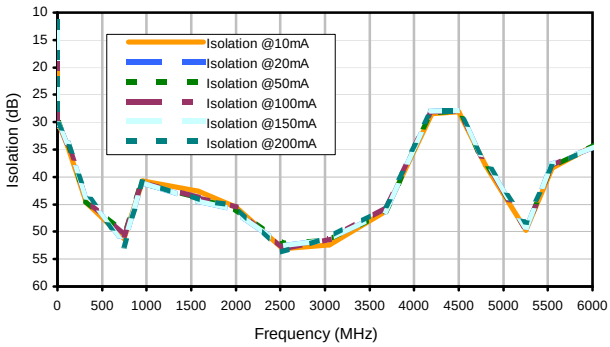
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Typical Performance Curves

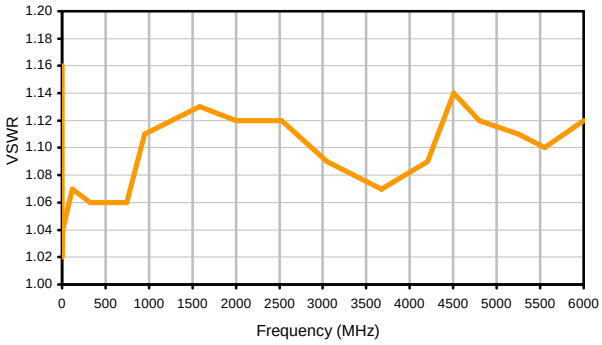
Insertion Loss



Isolation



VSWR

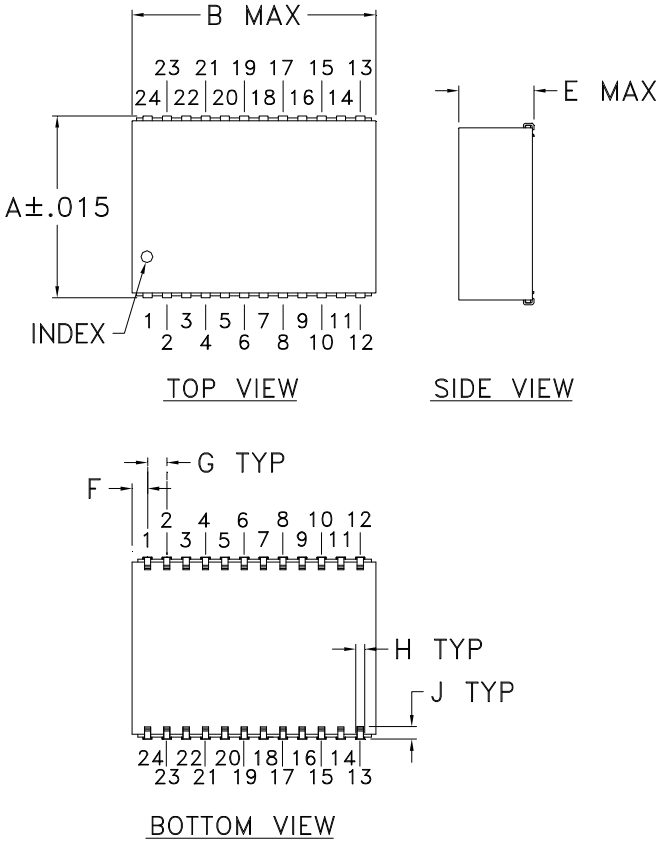


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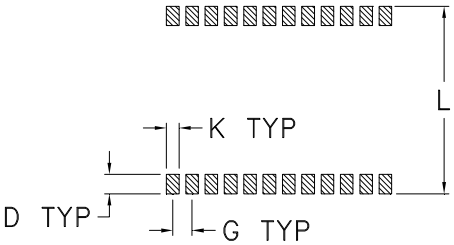
Case Style BL

BL301

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAM
BL301	.940 (23.88)	1.260 (32.00)	-- --	.100 (2.54)	.390 (9.91)	.080 (2.03)	.100 (2.54)	.047 (1.19)	.065 (1.65)	.065 (1.65)	.970 (24.64)	7.2

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

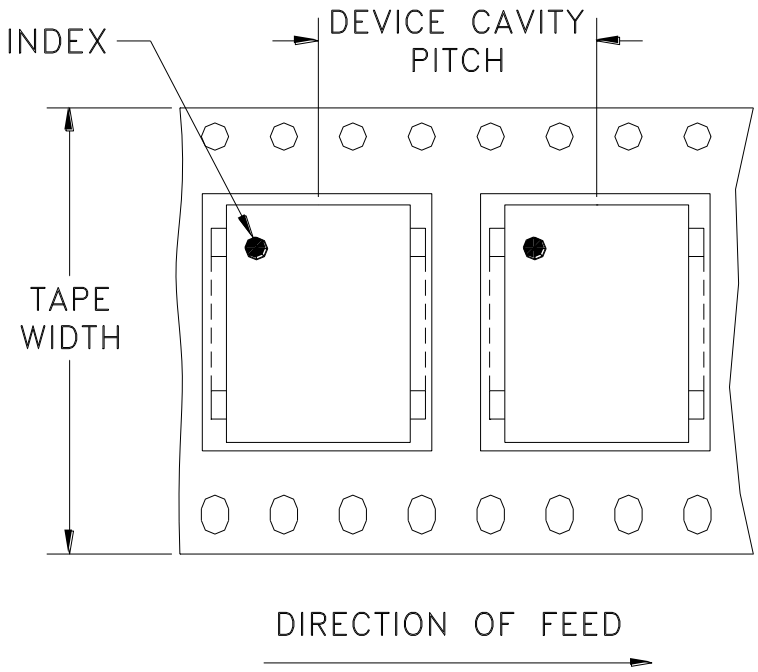
Notes:

1. Case material: Plastic.
2. Base material: Printed wiring laminate.
3. Termination finish:
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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Tape & Reel Packaging TR-F25

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
44	32	13	Small quantity standards (see note)	20
				50
				100
			Standard	125

Note: Please consult individual model data sheet to determine device per reel availability.

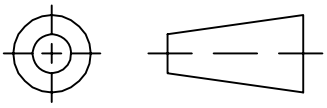
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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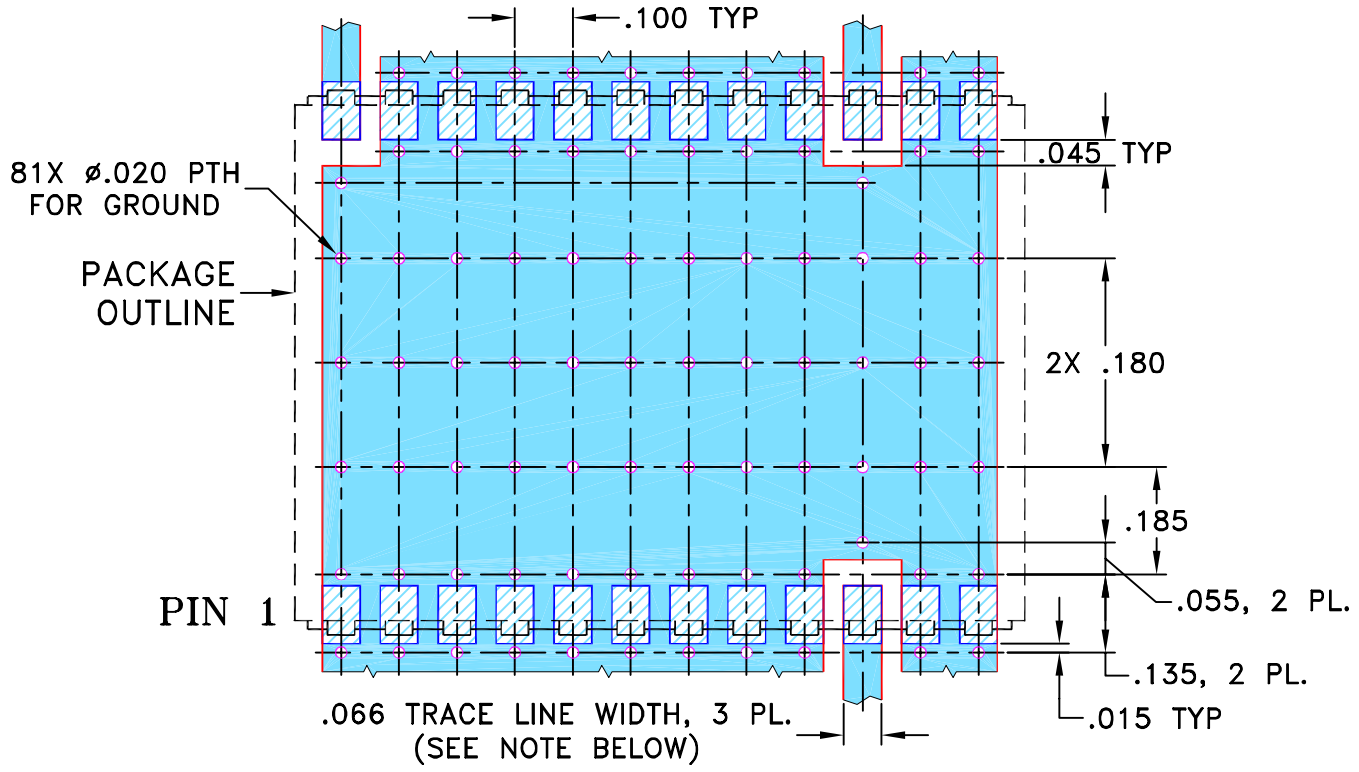
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M100847	NEW RELEASE	02/03/06	MMG	DY

SUGGESTED MOUNTING CONFIGURATION FOR BL301 CASE STYLE, "hr" PIN CONNECTION



NOTES:
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	MMG	12/21/05
TOLERANCES ON:	CHECKED	AV	01/03/06
2 PL DECIMALS ±	APPROVED	DY	02/03/06
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

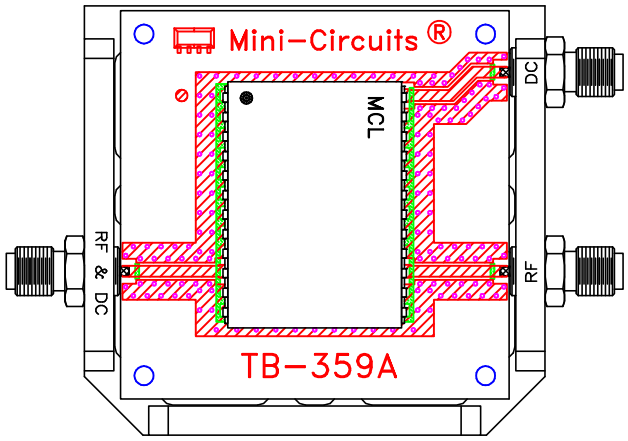
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PL, hr, BL301, JEBT, TB-359

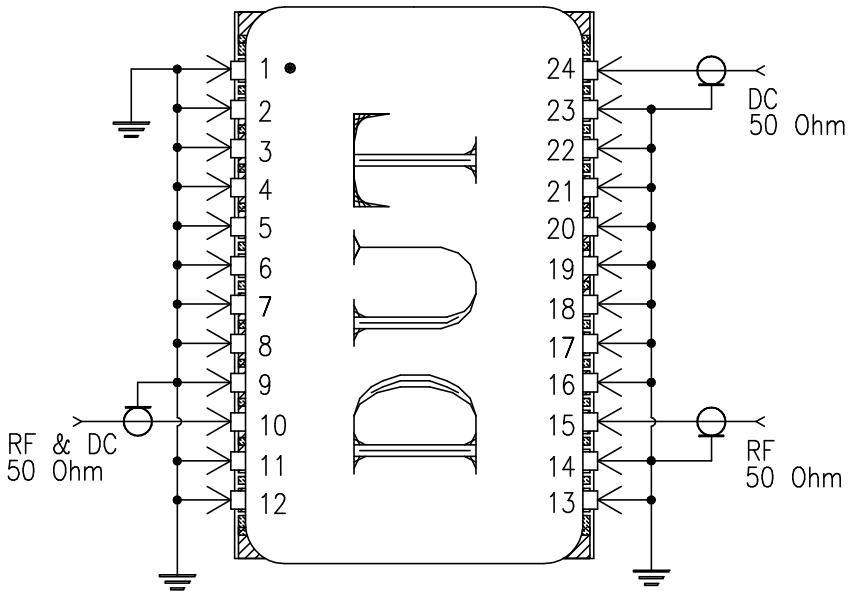
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-216	OR

FILE:	SCALE:	SHEET:
98PL216	3:1	1 OF 1

Evaluation Board and Circuit



TB-359



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

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